

Product Specification For LCD Module

Model NO.: CNKT0500-18023A2 CUSTOMERITEM NO.: REVISION : A

□ APPROVAL FOR SPECIFICATIONS ONLY

APPROVAL FOR SPECIFICATIONS AND SAMPLE

CUSTOMER :

APPROVED BY :



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TABLE OF CONTENTS

NO. CONTENTS	PAGE
REVISION STATUS	2
TABLE OF CONTENTS	
1. GENERAL DESCRIPTION	
2. MECHANICAL SPECIFICATION	5
3. PIN DESCRIPTION	
4. BLOCK DIAGRAM	7
5. ELECTRICAL CHARACTERISTICS	8
6.INPUT SIGNAL TIMING	11
7. OPTICAL CHARACTERISTICS	
8. QUALITY ASSURANCE SYSTEM	
9. PRECAUTION RELATING PRODUCT HANDLING	17
10. PACKAGE DRAWING	



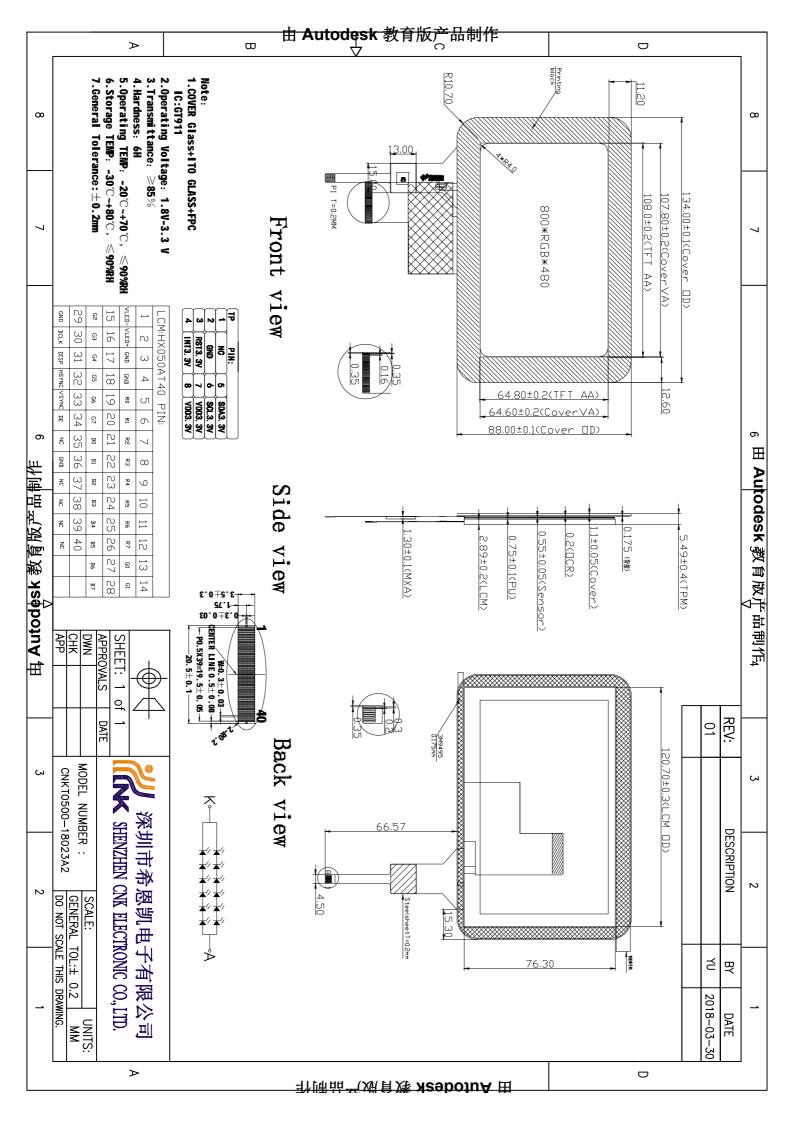
1. GENERAL DESCRIPTION

1.1 D

CNKT0500-18023A2 is a transmissive type color active matrix liquid crystal display (LCD) which usesamorphous thin film transistor (TFT) as switching devices. This product is composed of a TFTLCD panel, driver ICs, FPC and Backlight.

1.2 FEATURES:

No.	Item	Specification	Unit
1	Panel Size	5"	inch
2	Number of Pixels	800(W) x 3(RGB) x480(H)	pixels
3	Active Area	108.00(H) x 64.8(V)	mm
4	Pixel Pitch	0.135(W) x 0.135(H)	mm
5	OutlineDimension	134.00 (W) ×75.80(H) ×3.05(T)	mm
6	Pixel arrangement	RGB vertical stripe	-
7	Display Mode	Normally white	-
8	Viewing Direction	6 o'clock	-
9	Display Color	16.7M	-
10	Luminance(cd/m2)	300(TYP)	nit
11	Contrast Ratio	450(Min)	-
12	Surface Treatment	Antiglare, Hard-Coating (3H)	-
13	Interface	24-bit TTL	-
14	Backlight	White LED	-
15	Drive IC	GT911	-
16	Operation Temperature	-20~70	°C
17	Storage Temperature	-30~80	°C
18	Weight	_	g



3. PIN DESCRIPTION

FPC connector is used for electronics interface. The recommended model is FH19SC-40S-0.5SH (51) manufactured by HIROSE.

No.	Symbol	I/0	Function	Remark
1	VLED-	Р	Power for LED backlight cathode	
2	VLED+	Р	Power for LED backlight anode	
3	GND	Р	Power ground	
4	VDD	Р	Power voltage	
5	RO	I	Red data (LSB)	
6	R1	I	Red data	
7	R2	I	Red data	
8	R3	I	Red data	
9	R4	I	Red data	
10	R5	I	Red data	
11	R6	I	Red data	
12	R7	I	Red data (MSB)	
13	G0	I	Green data (LSB)	
14	G1	I	Green data	
15	G2	I	Green data	
16	G3	I	Green data	
17	G4	I	Green data	
18	G5	I	Green data	
19	G6	I	Green data	
20	G7	I	Green data (MSB)	
21	BO	I	Blue data (LSB)	
22	B1	I	Blue data	
23	B2	I	Blue data	
24	B3	I	Blue data	
25	B4	I	Blue data	
26	B5	I	Blue data	
27	B6	I	Blue data	
28	B7	I	Green data (MSB)	
29	DGND	I	Digital ground	
30	DCLK	I	Pixel clock	
31	DISP	I	Display on/ off	*1
32	Hsync	I	Horizontal sync signal	
33	Vsync		Vertical sync signal	
34	DE	I	Data enable	
35	NC	-	No Connect	
36	GND	Р	Power ground	
37	NC	-	No Connect	
38	NC	-	No Connect	
39	NC	-	No Connect	
40	NC	-	No Connect	

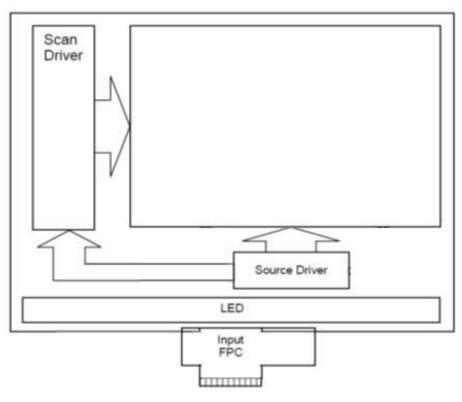
I/O: I: input, O: output, P: power

*1 : DISP=0;Sourcediriver will turn off. DISP =1;Normally operation

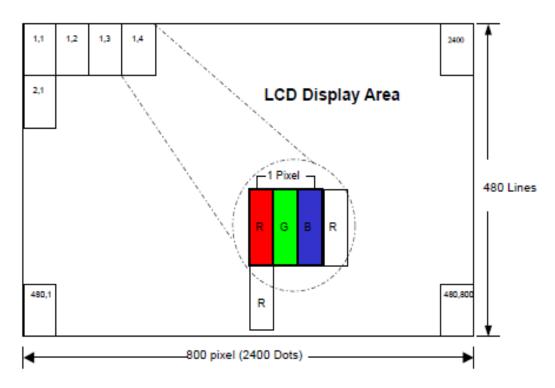


4.BLOCK DIAGRAM

4.1 TFT LCD MODULE



4.2 PIXEL FORMAT



5. ELECTRICAL CHARACTERISTICS

5.1 Absolute Maximum Ratings

	la = 25	С С			
ltom	Symbol	Va	lues	Unit	Remark
item	Item Symbol Min. Max.		Max.	Onit	Remark
	VDD	-0.5	5	V	-
Power Voltage	VGH	-0.3	40	V	-
rower voltage	VGL	-20	0.3	V	-
	VGH-VGL	-0.3	40	V	-

200

5.2 DC CHARACTERISTICS

5.2.1 Operating Conditions

Item	Symbol		Unit		
nem	Symbol	Min.	Тур.	Max.	Unit
TFT Gate On Voltage	VGH	21	22	23	
TFT Gate Off Voltage	VGL	-6	-7	-8	
TFT Common Electrode Voltage	Vcom	2.5	-	2.9	

5.2.2Current Consumption

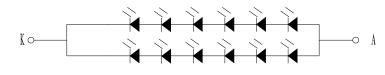
Item	Symbol Condition			Values	Unit	Remark	
nem	Symbol	Condition	Min.	Тур.	Max.	Onit	Kennark
Gate on Current	IVGH	VGH =21.8 V	-	9.7	-	mA	
Gate off Current	IVGL	VGL = -7.7 V	-	11.7	-	mA	
Digital Current	IDVDD	DVDD = 3.3V	-	141.2	-	mA	
Analog Current	IAVDD	AVDD = 12.55V	-	25.2	-	mA	

5.3 BACKLIGHT UNIT

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
LED Current	lled		40		mA	12LEDS
Forward Voltage	VF	18	18.6	19.8	V	IF=40mA
Reverse Current	IR			100	μA	VR=35V,14LEDS
Luminous Tolerance	IV-M	75	80		%	(MIN/MAX) $ imes$ 100
Power Dissipation	Pd		1008		mW	12LEDS
Peak Forward Current	lfp	60		mA	12LEDS	
Reverse Voltage	VR				۷	12LEDS



5.3.1 Internal Circuit Diaguam



CURRENT IF=40mA2*20=40mA

5.4 Power Sequence

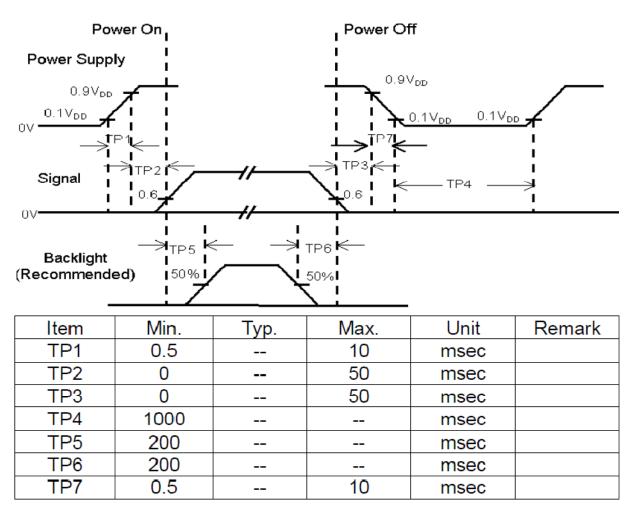
Power On Sequence

To prevent the device damage from latch up, the power on/off sequence shown below must be followed.

Power ON: VDD, VSS \rightarrow AVDD, VSSA \rightarrow V1 to V14

Power OFF: V1 to V14 \rightarrow AVDD, VSSA \rightarrow VDD, VSS

5.4.1 Power on/off control



Note :

(1) The supply voltage of the external system for the module input should be the same as the definition of VDD.

(2) Apply the lamp volatge within the LCD operation range. When the back-light turns



on before the LCD operation or the LCD truns off before the back-light turns off, the display may momentarily become white.

(3) In case of VDD = off level, please keep the level of input signal on the low or keep a high impedance.

(4) TP4 should be measured after the module has been fully discharged between power off and on period.

(5) Interface signal shall not be kept at high impedance when the power is on.

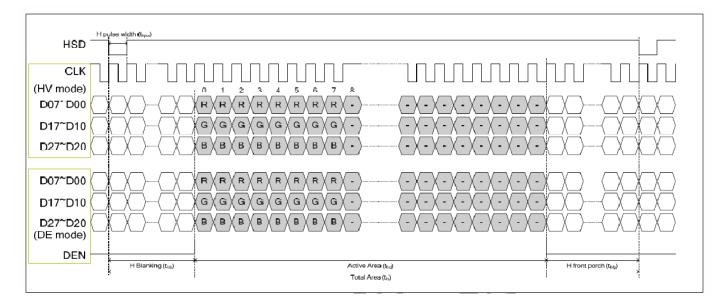
6.INPUT SIGNAL TIMING

6.1 AC CHARACTERISTICS

Parameters	Symbol		Spec.	Unit	Conditions	
Parameters	Symbol	Min.	Min. Typ.		Unit	Conditions
HS setup time	Thst	8	-	-	ns	
HS hold time	Thhd	8	-	-	ns	
VS setup time	Tvst	8	-	-	ns	
VS hold time	Tvhd	8	-	-	ns	
Data setup time	Tdsu	8	-	-	ns	
Data hold time	Tdhd	8	-	-	ns	
DE setup time	Tesu	8	-	-	ns	
DE hold time	Tehd	8	-	-	ns	
VDD Power On Slew rate	TPOR	-	-	20	ms	
RSTB pulse width	TRst	10	-	-	US	
CLKIN cycle time	Tcph	20	-	-	ns	
CLKIN pulse duty	Tcwh	40	50	60	%	
Output stable time	Tsst	-	-	6	US	

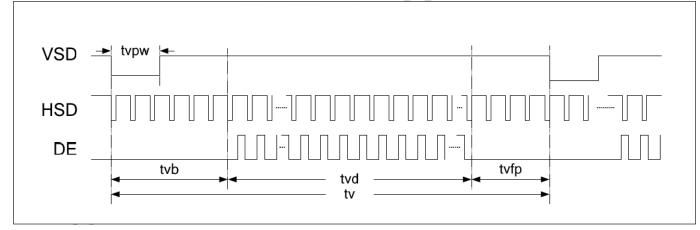


6.2DATA INPUT FORMAT Horizontal timing



Parameters	Symbol		Spec.	Unit	Conditions	
Faiameters	Symbol	Min.	in. Typ.		Unit	Conditions
Horizontal Display Area	thd		800		DCLK	
DCLK frequency	fclk	-	30	50	MHz	
One Horizontal Line	th	889	928	1143	DCLK	
HS pulse width	thpw	1	48	255	DCLK	
HS Back Porch (Blanking)	thb		88		DCLK	
HS Front Porch	thfp	1	40	255	DCLK	
DE mode Blanking	th-thd	85	128	512	DCLK	

Vertical timing



Parameters	Symbol		Spec.	Unit	Conditions	
Falameters	Symbol	Min.	in. Typ. Max.		Unit	Conditions
Vertical Display Area	tvd		480		TH	
VS period time	tv	513	525	767	TH	
VS pulse width	tvpw	3	3	255	TH	
VS Back Porch (Blanking)	tvb		32		TH	
VS Front Porch	tvfp	1	13	255	TH	
DE mode Blanking	tv-tvd	4	45	255	TH	

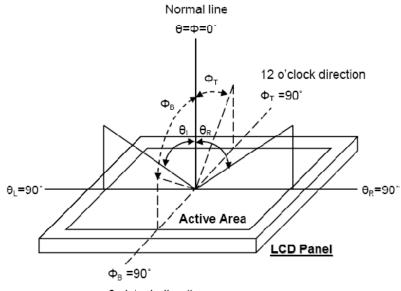
6.3TIMING WAVEFORM TABLE 6.3.1Parallel 24-bit RGB mode

Deremeters	Sumbol		Spec.		Unit	Conditions	
Parameters	Symbol	Min.	. Typ. Max.		Unit		
CLKIN Frequency	Fclk	-	40	50	MHz	VDD=3.0V~3.6V	
CLKIN Cycle Time	Tclk	20	25	-	ns	-	
CLKIN Pulse Duty	Tcwh	40	40 50 60		%	Tclk	
Time from HSD to Source Output	Thso		64		CLKIN	-	
Time from HSD to LD	Thld		64		CLKIN	-	
Time from HSD to STV	Thstv		2		CLKIN	-	
Time from HSD to CKV	Thckv		20		CLKIN	-	
Time from HSD to OEV	Thoev		4		CLKIN	-	
LD Pulse Width	Twld		10		CLKIN	-	
CKV Pulse Width	Twckv		66		CLKIN	-	
OEV Pulse Width	Twoev		74		CLKIN	-	

7. OPTICAL CHARACTERISTICS

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Contrast Ratio		CR	*1)	450		-		Note3
Brightness		В		250	300	-	cd/m2	
Response Time		TON	25 ℃	-	20	25	ms	Note4
		TOFF						
	Red	Rx	θ = φ=0°	0.570	0.600	0.630	-	Note3 Note6 Note7
		Ry		0.320	0.350	0.380	-	
	Green	Gx	θ = φ=0°	0.290	0.320	0.350	-	
Color Chromaticit		Gy		0.570	0.600	0.630	-	
y	Blue	Вх	θ = φ = 0°	0.110	0.140	0.170	-	
,		Ву		0.070	0.100	0.130	-	
	White	Wx	θ = φ=0°	0.250	0.290	0.330	-	
		Wy		0.290	0.330	0.370	-	
View angle		θΤ	CR≧10	40	50	-	deg.	Note5
		θΒ		60	70	-		
		θL		60	70	-		
		θR		60	70	-		
NTSC					54		%	

Note1: Ambient condition: $25^{\circ}C \pm 2^{\circ}C$, $60 \pm 10\%$ RH, under 10 Lunx in the darkroom. Note2: Definition of viewing angle range



6 o'clock direction

Fig. 6-1 Definition of viewing angle

Note3:Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, themeasurement should be executed. Measurement should be executed in a stable, windless, anddark room. Optical specifications are measured by Topcon BM-7



luminance meter 1.0 $^{\circ}$ field of view at a distance of 50cm and normal direction.

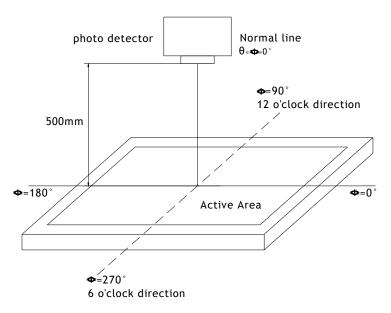


Fig. 6-2 Optical measurement system setup

Note4: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" stateand "Black" state. Rise time, Tr, is the time between photo detector output intensity changed from 90\% to 10\%. And fall time, Tf, is the time between photo detector output intensity changed from 10% to 90%

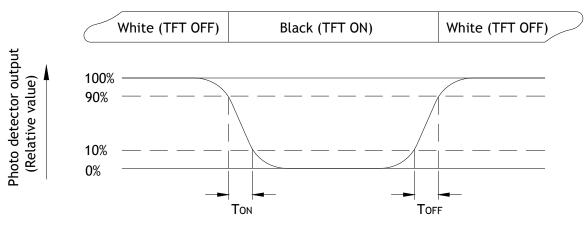


Fig. 6-3 definition of response time

Note5: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

Luminance measured when LCD on the "White" state

Contrast ratio (CR)=

Luminance measured when LCD on the "Black" state

Note6: Definition of color chromaticity (CIE 1931)

Color coordinates measured at the center point of LCD

Note7: Measured at the center area of the panel when all the input terminals of LCD panel areelectrically opened.

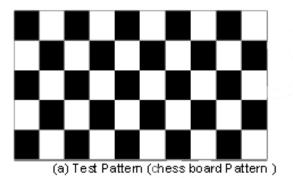
8. QUALITY ASSURANCE SYSTEM

8.1 TEMPERATURE AND HUMIDITY

Test Item	Test Condition	Remark
HighTemperatureStorage	Ta=80℃; 240hrs	
Low Temperature Storage	Ta=-30°C; 240hrs	
High Temperature Operation	Ta=70°C,240Hrs	
LowTemperatureOperation	Ta=-20°C; 240hrs	
HighTemperatureHighHumidity Operation	Ta=60℃ ,90%RH ,240Hrs(no condensation)	
Thermal Shock	-20℃ (0.5h) ~ 70℃ (0.5h) / 100cycles	
Image Sticking	$25^\circ\!\!\mathbb{C}$; 4hrs	Note1

Note1:Condition of image sticking test :25°C±2°C

Operation with test pattern sustained for 4hrs, then change to gray pattern immediately.after5 mins, themura must be disappeared completely





(b) Gray Pattern

8.2 VIBRATION&SHOCK

Test item	Conditions				
Packing Shock (non-operation)	980m/s2,6ms, ±x,y,z 3times for direction				
Packing Vibration (non-operation)	Frequency range:10 HZ~50HZ Stroke:1.0mm,sweep:10 HZ ~50HZ x,y,z 2 hours for each direction				

8.3ESD

Test item	Conditions	Note
Electro Static Discharge Test	150pF , 330Ω , Contact:±4KV,Air:±8KV	1
(non-operation)	200pF , 0Q , ±200V contact test	2

Note: Measure point :

- 1. LCD glass and metal bezel
- 2. IF connector pins



9. PRECAUTION RELATING PRODUCT HANDLING

9.1 MOUNTING PRECAUTIONS

(1) You must mount a module using arranged in four corners or four sides.

(2)You should consider the mounting structure so that uneven force (ex. Twisted stress) is notapplied to the module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.

(3) Please attach a transparent protective plate to the surface in order to protect thepolarizer. Transparent protective plate should have sufficient strength in order to the resist external force.

(4) You should adopt radiation structure to satisfy the temperature specification.

(5) Acetic acid type and chlorine type materials for the cover case are not describe because the former generates corrosive gas of attacking the polarizer at high temperature and the latter causes circuit break by electro-chemical reaction.

(6) Do not touch, push or rub the exposed polarizers with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of polarizer for bare hand or greasy cloth. (Some cosmetics are determined to the polarizer)

(7) When the surface becomes dusty, please wipe gently with adsorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach front / rear polarizers. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.

(8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.

(9) Do not open the case because inside circuits do not have sufficient strength.

9.2 OPERATING PRECAUTIONS

(1) The spike noise causes the mis-operation of circuits. It should be lower than following voltage_V= $\pm 200 \text{mV}(\text{Over and under shoot voltage})$

(2) Response time depends on the temperature. (In lower temperature, it becomes longer.)

(3) Brightness depends on the temperature. (In lower temperature, it becomes lower) And in lower temperature, response time (required time that brightness is stable after turned on) becomes longer.

(4) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot willoccur.

(5) When fixed patterns are displayed for a long time, remnant image is likely to occur.

(6) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.

9.3 ELECTROSTATIC DISCHARGE CONTROL

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wristband etc. Anddon't touch interface pin directly.

9.4 PRECAUTIONS FOR STRONG LIGHT EXPOSURE

Strong light exposure causes degradation of polarizer and color filter.



9.5 STORAGE

When storing modules as spares for a long time, the following precautions are necessary.

(1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keepthe temperature between 5 and 35 _ _ at normal humidity.

(2)The polarizer surface should not come in contact with any other object. It is recommended that they be stored in the container in which they were shipped.

9.6 HANDLING PRECAUTION FOR PROTECTION FILM

(1) When the protection film is peeled off, static electricity is generated between the film andpolarizer. This should be peeled off slowly and carefully by people who are electrically groundedand with well ion-blown equipment or in such a condition, etc.

(2) The protection film is attached to the polarizer with a small amount of glue. Is apt to remainon the polarizer. Please carefully peel off the protection film without rubbing it against the polarizer.

(3) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the polarizer after the protection film is peeled off.

(4) You can remove the glue easily. When the glue remains on the polarizer surface or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material likechamois soaked with normal-hexane.



1.INCOMING INSPECTION RIGHT

(1) The Incoming Inspection Standard will be agreed and signed by both sides(Customer and Starry) $% \left(\mathcal{L}_{1}^{2}\right) =\left(\mathcal{L$

2. INSPECTION CONDITIONS IS AS FOLLOWS:

(1) Viewing distance is approximately 35 ~ 40 cm

- (2) Viewing angle is normal to the LCD panel as Fig $-1(30^{\circ})$
- (3) Ambient temperature is approximately 25 \pm 5 $^{\circ}$ C
- (4) Ambient humidity is $60 \pm 5\%$ RH
- (5) Ambient illuminance is from 300 ~ 500 Lux.
- (6) Input signal timing should be typical value.
- (7) Mura & Light leakage inspection at ND-Filter 5%

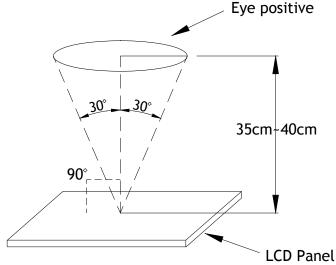


Fig-1

3. SPECIAL CONDITION

(1) Viewing distance is close for inspection of adjacent dots and distance between defect dots.

(2) Viewing condition of "Shot block non-uniformity from oblique angle" is as Fig-2.

(3) Exceptional case: View angle $\pm 40^{\circ}$ while inspected image-sticking.

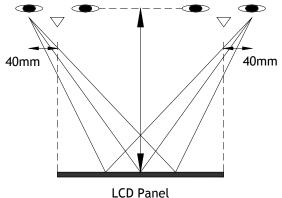


Fig-2

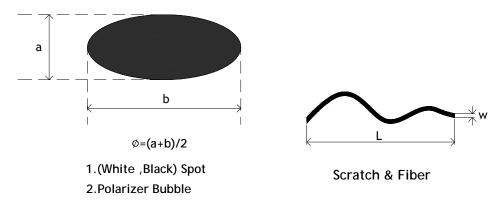


4. INSPECTION CRITERIA

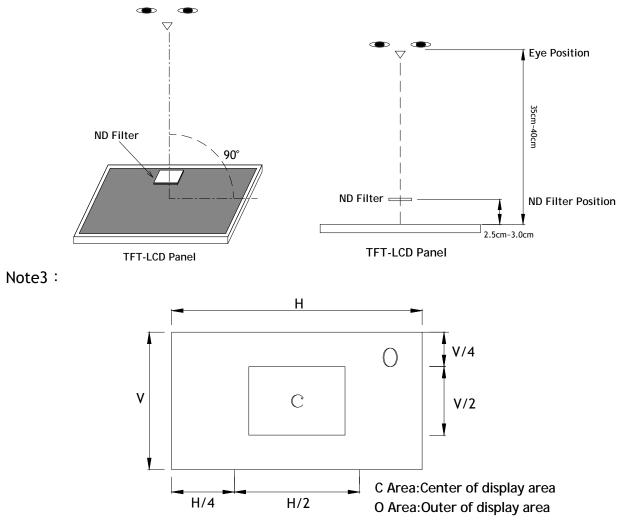
Defecttype			Limit			Note
	Scratch (in active area)		W≦0.0	W≦0.05mm Ignore		Note1
			0.05mm≦w≦0.1mm L≦10mm		N≦4	
			10mm <l, 0.1mm<w<="" td=""><td>N=0</td></l,>		N=0	
	Internal	Spot	Φ<0.2mm		Ignore	Note1
			$0.2mm \le \phi \le 0.3mm$		N≦3	
			0.3mm<φ		N=0	
		Fiber	W≦ 0.03		Ignore	Note1
Visual defect			$0.03 < W \le 0.04$ L ≤ 5.0		$N \leq 4$	
			0.04< W, L>5.0		N=0	
		Polarizer bubble	Φ<0.2mm		Ignore	Note1
			$0.2mm \leq \phi \leq 0.3mm$		N≦1	
			0.3mm<φ		N=0	
		Dent	Φ<0.1mm		Ignore	Note1
		Dent	$0.1mm \! \leq \! \phi \! \leq \! 0.25mm$		N≦2	
	Mura & Gap		Not visible through 5% ND filter			
Electrical Defect	Bright dot		C Area	0 Area	Total	
			N≦0	N≦1	N≦1	Note2
	Dark dot		N≦1	N≦2	N≦3	Note3
	Total dot		N≦1	N≦3	N≦3	
	Two adjacent dot		Not allowed			Note4
	Three or more adjacent dot		Not allowed			
	Line defect		Not allowed			-
(1) one pixel co (2) panel is acco						



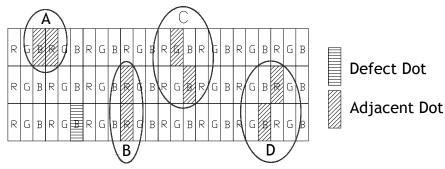
Note1 : W : Width[mm], L : Length[mm], N : Number, φ : Average Diameter



Note 2 : Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixelarea.



Note4 : Judge defect dot and adjacent dot as following. Allow below (as A, B, C and D status) adjacent defect dots, including bright and dart adjacent dot. And they will be counted 2defect dots in total quantity.



Note5 : Other condition

(1) The defects that are not defined above and considered to be problem shall be reviewedanddiscussed by both parties.

(2) Defects on the Black Matrix, out of Display area, are not considered as a defect or counted.

5. HANDLING PRECAUTION

- (1) Don't disassemble and reassemble the module by self.
 (禁止自行拆解)
- (2) Acid, alkali, alcohol or touched directly by hand will damage the display.
 (酸性、碱性、酒精或手的直接接触将会损伤显示面)
- (3) Static electricity will damage the module. Please configure grounding device. (静电会损伤模组,请装配接地设备)

(4) The strong vibration, shock, twist or bend will cause material damage, even module broken.

(强烈的撞击、震动、扭转或弯曲将会造成原材损伤,甚至面板破裂)

- (5) It is easy to cause image sticking while displaying the same pattern for very long time. (长期显示同一画面会造成影像残留)
- (6) The response time, brightness and performance will vary from different temperature. (响应时间、亮度与均匀性会因温度而有所改变)
- (7) 12 months of the product term, the Microtech shipment date began to count. (从希恩凯出货之日开始产品保质期为 12 个月)